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March 2013

# **FQP17P06** P-Channel QFET® MOSFET

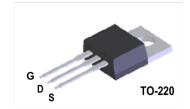
- 60 V, - 17 A, 120  $m\Omega$ 

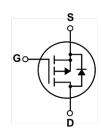
#### Description

This P-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor®'s proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, audio amplifier, DC motor control, and variable switching power applications.

#### **Features**

- - 17 A, 60 V,  $R_{DS(on)}$  = 120 m $\Omega$  (Max.) @  $V_{GS}$  = 10 V, ID = -8.5 A
- Low Gate Charge (Typ.21 nC)
- Low Crss (Typ. 80 pF)
- · 100% Avalanche Tested
- 175°C Maximum Junction Temperature Rating





## Absolute Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted

3					
Symbol	Parameter			FQP17P06	Unit
V <sub>DSS</sub>	Drain-Source Voltage		-60	V	
I <sub>D</sub>	Drain Current	- Continuous (T <sub>C</sub> = 25°C)		-17	А
		- Continuous (T <sub>C</sub> = 10	0°C)	-12	А
I <sub>DM</sub>	Drain Current	- Pulsed	(Note 1)	-68	А
V <sub>GSS</sub>	Gate-Source Vo	ource Voltage		± 25	V
E <sub>AS</sub>	Single Pulsed Avalanche Energy		(Note 2)	300	mJ
I <sub>AR</sub>	Avalanche Current		(Note 1)	-17	А
E <sub>AR</sub>	Repetitive Avalanche Energy		(Note 1)	7.9	mJ
dv/dt	Peak Diode Recovery dv/dt		(Note 3)	-7.0	V/ns
P <sub>D</sub>	Power Dissipation (T <sub>C</sub> = 25°C)			79	W
	- Derate above 25°C			0.53	W/°C
$T_J$ , $T_{STG}$	Operating and Storage Temperature Range			-55 to +175	°C
T <sub>L</sub>	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds			300	°C

## **Thermal Characteristics**

Symbol	Parameter	FQP17P06	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case, Max.	1.9	°C/W
$R_{\theta CS}$	Thermal Resistance, Case-to-Sink, Typ.	0.5	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient, Max.	62.5	°C/W

Symbol	Parameter Test Conditions		Min	Тур	Max	Unit
Off Cha	racteristics					
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V, I}_{D} = -250 \mu\text{A}$	-60			V
ΔBV <sub>DSS</sub> / ΔT <sub>J</sub>	Breakdown Voltage Temperature Coefficient	I <sub>D</sub> = -250 μA, Referenced to 25°C		-0.06		V/°C
I <sub>DSS</sub>	Zara Cata Valtaga Drain Current	V <sub>DS</sub> = -60 V, V <sub>GS</sub> = 0 V			-1	μΑ
	Zero Gate Voltage Drain Current	V <sub>DS</sub> = -48 V, T <sub>C</sub> = 150°C			-10	μΑ
I <sub>GSSF</sub>	Gate-Body Leakage Current, Forward	V <sub>GS</sub> = -25 V, V <sub>DS</sub> = 0 V			-100	nA
I <sub>GSSR</sub>	Gate-Body Leakage Current, Reverse	V <sub>GS</sub> = 25 V, V <sub>DS</sub> = 0 V			100	nA
On Cha	racteristics					
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = -250 μA	-2.0		-4.0	V
R <sub>DS(on)</sub>	Static Drain-Source On-Resistance	V <sub>GS</sub> = -10 V, I <sub>D</sub> = -8.5 A		0.094	0.12	Ω
9 <sub>FS</sub>	Forward Transconductance $V_{DS} = -30 \text{ V}, I_{D} = -8.5 \text{ A}$			9.3		S
C <sub>iss</sub>	Input Capacitance  Output Capacitance  Reverse Transfer Capacitance    VDS = -25 V, VGS = 0 V,   F = 1.0 MHz			690 325 80	900 420 105	pF pF
C <sub>rss</sub>	Reverse Transfer Capacitance f = 1.0 MHz			80	105	рF
Switchi	ng Characteristics					
t <sub>d(on)</sub>	Turn-On Delay Time $V_{DD} = -30 \text{ V, } I_{D} = -8.5 \text{ A,}$ $R_{G} = 25 \Omega$			13	35	ns
t <sub>r</sub>				100	210	ns
$t_{d(off)}$	Turn-Off Delay Time	3		22	55	ns
t <sub>f</sub>	Turn-Off Fall Time	(Note 4)		60	130	ns
$Q_g$	Total Gate Charge	V <sub>DS</sub> = -48 V, I <sub>D</sub> = -17 A,		21	27	nC
Q <sub>gs</sub>	Gate-Source Charge	V <sub>GS</sub> = -10 V		4.2		nC
$Q_{gd}$	Gate-Drain Charge (Note 4)			10		nC
Drain-S	ource Diode Characteristics ar	nd Maximum Ratings				
I <sub>S</sub>	Maximum Continuous Drain-Source Diode Forward Current				-17	Α
I <sub>SM</sub>	Maximum Pulsed Drain-Source Diode F				-68	Α
V <sub>SD</sub>	Drain-Source Diode Forward Voltage	V <sub>GS</sub> = 0 V, I <sub>S</sub> = -17 A			-4.0	V
t <sub>rr</sub>	Reverse Recovery Time	V <sub>GS</sub> = 0 V, I <sub>S</sub> = -17 A,		92		ns
		$dI_F/dt = 100 A/\mu s$	1	_	1	

Notes: 
1. Repetitive Rating : Pulse width limited by maximum junction temperature 
2. L = 1.2mH, I $_{AS}$  = -17A, V $_{DD}$  = -25V, R $_{G}$  = 25  $\Omega$ , Starting T $_{J}$  = 25°C 
3. I $_{SD}$   $\le$  -17A, di/dt  $\le$  300A/ $_{HS}$ , V $_{DD}$   $\le$  BV $_{DSS}$ , Starting T $_{J}$  = 25°C 
4. Essentially independent of operating temperature

## **Typical Characteristics**

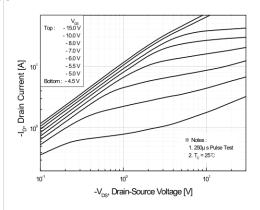


Figure 1. On-Region Characteristics

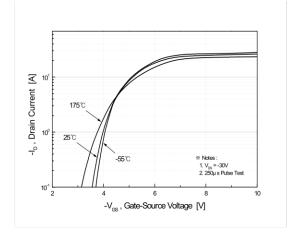


Figure 2. Transfer Characteristics

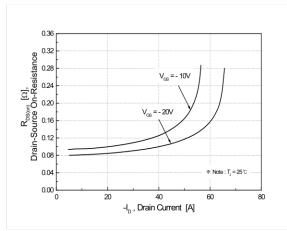


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

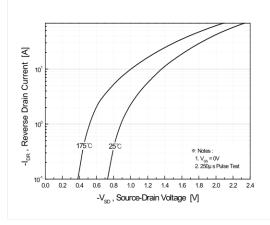


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

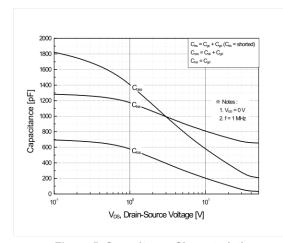


Figure 5. Capacitance Characteristics

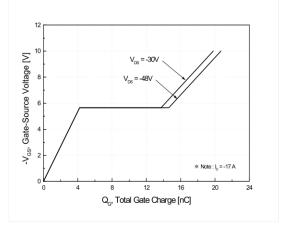
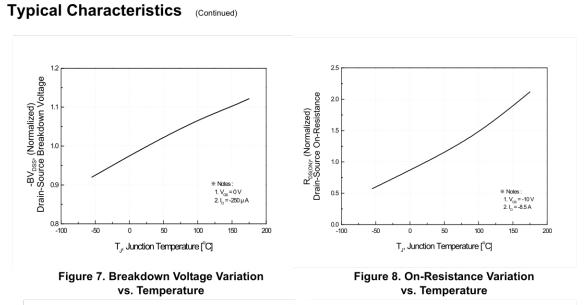


Figure 6. Gate Charge Characteristics



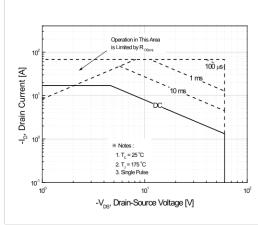


Figure 9. Maximum Safe Operating Area

Figure 10. Maximum Drain Current vs. Case Temperature

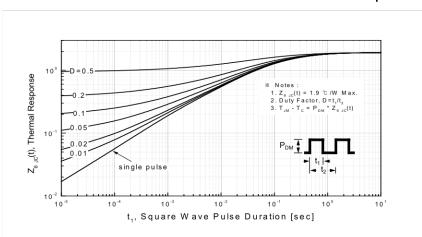
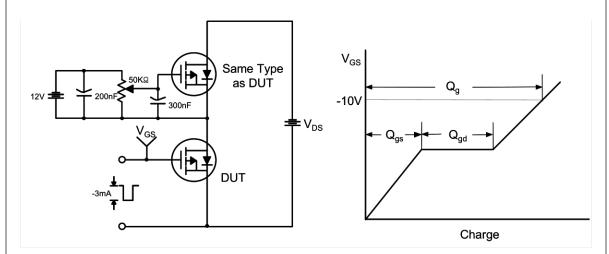
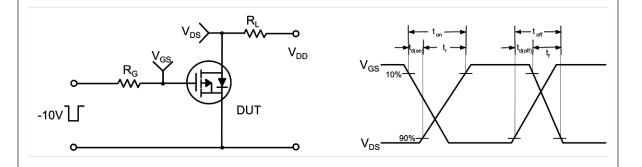


Figure 11. Transient Thermal Response Curve

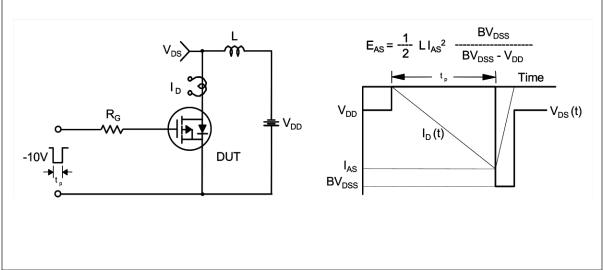
## **Gate Charge Test Circuit & Waveform**



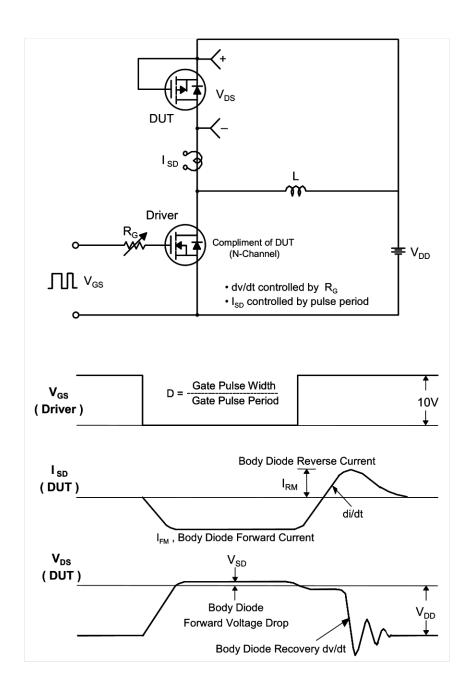
## **Resistive Switching Test Circuit & Waveforms**



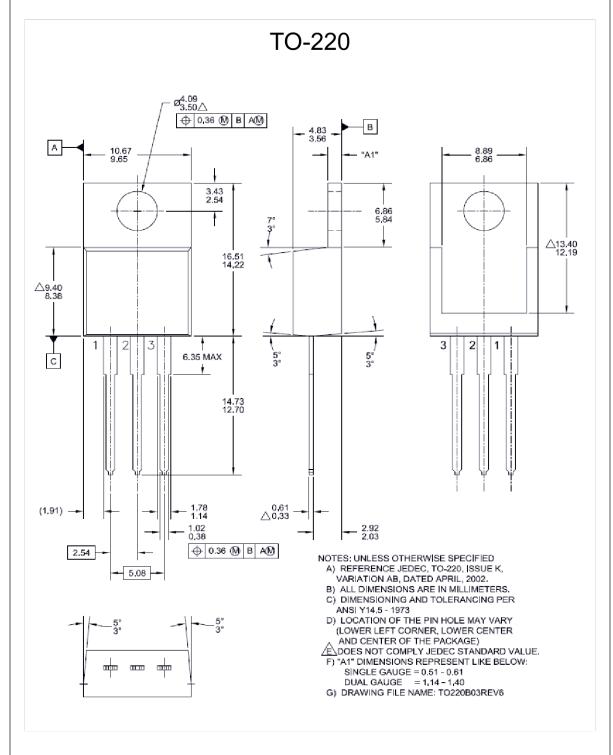
## **Unclamped Inductive Switching Test Circuit & Waveforms**



#### Peak Diode Recovery dv/dt Test Circuit & Waveforms



## **Package Dimensions**







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